

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
ZIEP TRAN	07/10/2014
KIYOSHI MORI	07/09/2014
GIANG T. DAO	07/08/2014
MICHAEL E. RAMON	07/10/2014
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PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	14329792
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ATTORNEY DOCKET NUMBER:	IN101301US1/51972.4
NAME OF SUBMITTER:	MICHAEL E. RAMON
SIGNATURE:	/Michael E. Ramon/
DATE SIGNED:	07/11/2014
Total Attachments: 2	
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source=51972_4_Assignment#page2.tif	

ASSIGNMENT OF INVENTION

For good and valuable consideration, the receipt of which is hereby acknowledged, I, an Assignor named below,

- (1) Ziep Tran of Austin, TX 78733, USA
- (2) Kiyoshi Mori of Missouri City, TX 77459, USA
- (3) Giang T. Dao of Milpitas, CA 95035, USA
- (4) Michael E. Ramon of Austin, TX 78704, USA

hereby sell, assign and transfer to

ASSIGNEE: INOSO, LLC, a Texas Corporation, having a principal place of business at 110 S. Laurelwood Drive, Austin, TX 78733, USA,

its successors, assigns and legal representatives, my entire right, title and interest throughout the world, including all rights to claim priority, in and to the invention disclosed in U.S. Patent Application executed on or about the date of this Assignment:

ENTITLED: **METHOD OF FORMING A STACKED LOW TEMPERATURE DIODE AND RELATED DEVICES**, and naming as

INVENTOR(S): Ziep Tran, Kiyoshi Mori, Giang T. Dao, and Michael E. Ramon,

("Invention") including without limitation, my entire right, title and interest in and to any and all United States and foreign applications (including international, regional and foreign national applications) for said Invention, including divisions, continuations, continuations-in-part, utility models, industrial designs, renewals, substitutes and extensions thereof, and in and to any and all patents, invention registrations, or other forms of protection ("Patents") of every country or region that may be granted or have been granted for said Invention, including any reissues and reexaminations thereof.


To comply with 37 C.F.R. § 3.21 for recording this Assignment, I authorize and request that the application number and filing date be inserted here, if not already shown above, (_____/_____/_____, filed _____) when they become known.


I authorize Assignee to apply for patents in foreign countries for said Invention, and to claim all rights of priority without further authorization from me.

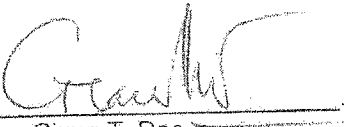
I agree that, upon request and without further compensation, but at no expense to me, I and/or my legal representatives and assigns will do all lawful acts, including the execution of papers and the giving of testimony, that may be necessary or desirable for obtaining, sustaining, reissuing, or enforcing the Patents in the United States and throughout the world for said Invention, and for perfecting, recording, or maintaining the title of Assignee, its successors and assigns, to said Invention, said application, and any Patents granted for said Invention in the United States and throughout the world.

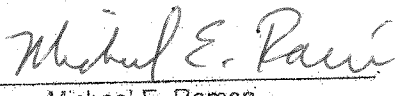
I hereby covenant that no assignment, sale, license, agreement, or encumbrance has been or will be made or entered into that would conflict with this Agreement.

I authorize and request the Director of the United States Patent and Trademark Office and agencies, departments, or other similar offices and officials of all foreign countries to issue and Patents granted for said Invention, whether on said application or on any subsequently filed divisional, continuation, continuation-in-part, reexamination, reissue or other application, to Assignee, its successors and assigns, as the assignee of the entire interest in said Invention.

(1) Executed on JULY 10th, 2014, by 
Ziep Tran

(2) Executed on July 9, 2014, by 
Kiyoshi Mori

(3) Executed on July 8, 2014, by 
Giang T. Dao

(4) Executed on July 10, 2014, by 
Michael E. Ramon